RENESAS

DATASHEET

X9259

Single Supply/Low Power/256-Tap/2-Wire Bus Quad Digitally-Controlled (XDCP[™]) Potentiometers

FN8169 Rev 6.00 December 12, 2014

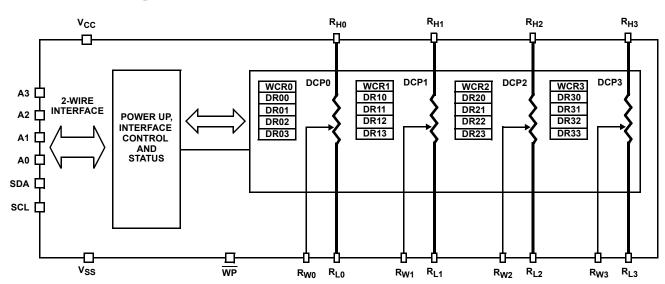
The X9259 integrates four digitally controlled potentiometers (XDCP) on a monolithic CMOS integrated circuit.

The digitally controlled potentiometers are implemented with a combination of resistor elements and CMOS switches. The position of the wipers are controlled by the user through the 2-wire bus interface. Each potentiometer has associated with it a volatile Wiper Counter Register (WCR) and four nonvolatile Data Registers that can be directly written to and read by the user. The content of the WCR controls the position of the wiper. At power-up, the device recalls the content of the default Data Registers of each DCP (DR00, DR10, DR20, and DR30) to the corresponding WCR.

The XDCP can be used as a three-terminal potentiometer or as a two-terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

Features

- · Four separate potentiometers in one package
- 256 resistor taps-0.4% resolution
- 2-wire serial interface for write, read, and transfer operations of the potentiometer
- Wiper resistance: 100Ω typical at V_{CC} = 5V
- 4 nonvolatile data registers for each potentiometer
- · Nonvolatile storage of multiple wiper positions
- Standby current <5µA max
- V_{CC}: 2.7V to 5.5V operation
- $50k\Omega$ version of total resistance
- Endurance: 100,000 data changes per bit per register
- 100 year data retention
- Single supply version of X9258
- 24 Ld SOIC, 24 Ld TSSOP
- Low power CMOS
- Pb-Free (RoHS compliant)



Functional Diagram

Ordering Information

PART NUMBER (<u>Notes 1</u> , <u>3</u>)	PART MARKING	V _{CC} LIMITS (V)	R _{TOTAL} (kΩ)	TEMP RANGE (°C)	PACKAGE (RoHS Compliant)	PKG. DWG. #
X9259US24Z (<u>Note 2</u>)	X9259US Z	5 ±10%	50	0 to +70	24 Ld SOIC	M24.3
X9259UV24Z	X9259UV Z			0 to +70	24 Ld TSSOP	M24.173
X9259US24IZ (<u>Note 2</u>)	X9259US ZI			-40 to +85	24 Ld SOIC	M24.3
X9259UV24IZ (<u>Note 2</u>)	X9259UV ZI			-40 to +85	24 Ld TSSOP	M24.173
X9259US24Z-2.7 (<u>Note 2</u>)	X9259US ZF	2.7 to 5.5		0 to +70	24 Ld SOIC	M24.3
X9259US24IZ-2.7 (<u>Note 2</u>)	X9259US ZG			-40 to +85	24 Ld SOIC	M24.3
X9259UV24Z-2.7	X9259UV ZF			0 to +70	24 Ld TSSOP	M24.173
X9259UV24IZ-2.7 (<u>Note 2</u>)	X9259UV ZG			-40 to +85	24 Ld TSSOP	M24.173

NOTES:

- Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 2. Add "T1" suffix for tape and reel.
- 3. For Moisture Sensitivity Level (MSL), please see product information page for X9259. For more information on MSL, please see tech brief TB363.

Circuit Level Applications

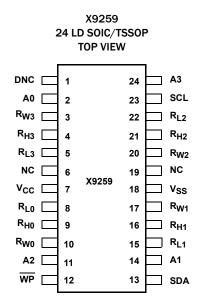
- · Vary the gain of a voltage amplifier
- Provide programmable DC reference voltages for comparators and detectors
- Control the volume in audio circuits
- Trim out the offset voltage error in a voltage amplifier circuit
- · Set the output voltage of a voltage regulator
- Trim the resistance in Wheatstone bridge circuits
- Control the gain, characteristic frequency and Q-factor in filter circuits
- Set the scale factor and zero point in sensor signal conditioning circuits
- · Vary the frequency and duty cycle of timer ICs
- Vary the DC biasing of a pin diode attenuator in RF circuits
- Provide a control variable (I, V, or R) in feedback circuits

System Level Applications

- · Adjust the contrast in LCD displays
- Control the power level of LED transmitters in communication systems
- Set and regulate the DC biasing point in an RF power amplifier in wireless systems
- · Control the gain in audio and home entertainment systems
- · Provide the variable DC bias for tuners in RF wireless systems
- Set the operating points in temperature control systems
- · Control the operating point for sensors in industrial systems
- Trim offset and gain errors in artificial intelligent systems



Pin Configuration



Pin Descriptions

PIN #	PIN NAME	DESCRIPTION
2	AO	Device Address for 2-wire bus. (See Note 4)
3	R _{W3}	Wiper Terminal of DCP3
4	R _{H3}	High Terminal of DCP3
5	R _{L3}	Low Terminal of DCP3
7	V _{CC}	System Supply Voltage
8	R _{LO}	Low Terminal of DCP0
9	R _{HO}	High Terminal of DCP0
10	R _{W0}	Wiper Terminal of DCP0
11	A2	Device Address for 2-wire bus. (See <u>Note 4</u>)
12	WP	Hardware Write Protect – Active Low
13	SDA	Serial Data Input/Output for 2-wire bus.
14	A1	Device Address for 2-wire bus. (See Note 4)
15	R _{L1}	Low Terminal of DCP1
16	R _{H1}	High Terminal of DCP1
17	R _{W1}	Wiper Terminal of DCP1
18	V _{SS}	System Ground
20	R _{W2}	Wiper Terminal of DCP2
21	R _{H2}	High Terminal of DCP2
22	R _{L2}	Low Terminal of DCP2
23	SCL	Serial Clock for 2-wire bus.
24	A3	Device Address for 2-wire bus. (See Note 4)
6, 19	NC	No Connect
1	DNC	Do Not Connect

NOTE:

4. A0 through A3 Device address pins must be tied to a logic level.



Functional Pin Descriptions

Bus Interface Pins

SERIAL DATA INPUT/OUTPUT (SDA)

The SDA is a bidirectional serial data input/output pin for a 2-wire slave device and is used to transfer data into and out of the device. It receives device address, opcode, wiper register address and data sent from a 2-wire master at the rising edge of the serial clock SCL, and it shifts out data after each falling edge of the serial clock SCL.

It is an open-drain output and may be wire-ORed with any number of open drain or open collector outputs. An open-drain output requires the use of a pull-up resistor.

SERIAL CLOCK (SCL)

This input is used by a 2-wire master to supply a 2-wire serial clock to the X9259.

DEVICE ADDRESS (A3 THROUGH A0)

The Address inputs are used to set the least significant 4 bits of the 8-bit slave address. A match in the slave address serial data stream must be made with the address input in order to initiate communication with the X9259. A maximum of 16 devices may occupy the 2-wire serial bus. Device pins A3 through A0 must be tied to a logic level, which specifies the external address of the device, see Figures 3, 4, and 5.

Potentiometer Pins

R_H, R_L

The R_H and R_L pins are equivalent to the terminal connections on a mechanical potentiometer. Since there are 4 potentiometers, there are 4 sets of R_H and R_L such that R_{H0} and R_{L0} are the terminals of DCP0 and so on.

Rw

The wiper pin are equivalent to the wiper terminal of a mechanical potentiometer. Since there are 4 potentiometers, there are 4 sets of ${\rm R}_W$ such that ${\rm R}_{W0}$ is the terminal of DCP0 and so on.

Bias Supply Pins

SYSTEM SUPPLY VOLTAGE (V_{CC}) AND SUPPLY GROUND (V_{SS})

The $V_{\mbox{CC}}$ pin is the system supply voltage. The $V_{\mbox{SS}}$ pin is the system ground.

Other Pins

NO CONNECT

No connect pins should be left open. These pins are used for Intersil manufacturing and testing purposes.

HARDWARE WRITE PROTECT INPUT (WP)

The $\overline{\text{WP}}$ pin when LOW, prevents nonvolatile writes to the Data Registers.

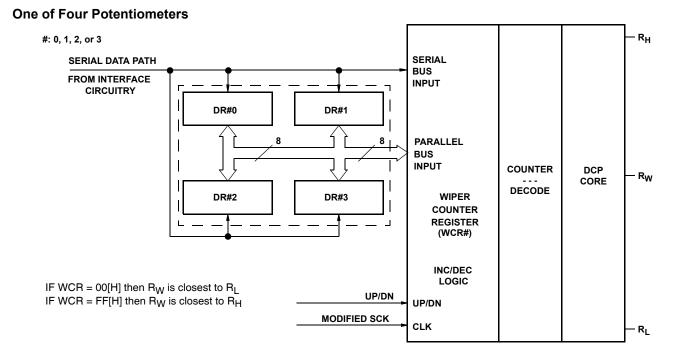


FIGURE 1. DETAILED POTENTIOMETER BLOCK DIAGRAM



Principles of Operation

The X9259 is an integrated circuit incorporating four DCPs and their associated registers and counters, and the serial interface providing direct communication between a host and the potentiometers.

DCP Description

Each DCP is implemented with a combination of resistor elements and CMOS switches. The physical ends of each DCP are equivalent to the fixed terminals of a mechanical potentiometer (R_H and R_L pins). The RW pin is an intermediate node, equivalent to the wiper terminal of a mechanical potentiometer.

The position of the wiper terminal within the DCP is controlled by an 8-bit volatile Wiper Counter Register (WCR).

Power Up and Down Recommendations

There are no restrictions on the power-up or power-down conditions of V_{CC} and the voltages applied to the potentiometer pins provided that V_{CC} is always more positive than or equal to $V_H,\,V_L,\,and\,V_W,\,i.e.,\,V_{CC}\geq V_H,\,V_L,\,V_W.$ The V_{CC} ramp rate specification is always in effect.

Wiper Counter Register (WCR)

The X9259 contains four Wiper Counter Registers, one for each potentiometer. The Wiper Counter Register can be envisioned as a 8-bit parallel and serial load counter with its outputs decoded to select one of 256 wiper positions along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the Write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated data registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/Decrement instruction (see <u>"Instructions"</u> section on <u>page 8</u> for more details). Finally, it is loaded with the contents of its data register zero (DR#0) upon power-up, (see <u>Figure 1 on page 4</u>).

The Wiper Counter Register is a volatile register; that is, its contents are lost when the X9259 is powered-down. Although the register is automatically loaded with the value in DR#0 upon power-up, this may be different from the value present at power-down. Power-up guidelines are recommended to ensure proper loadings of the DR#0 value into the WCR# (see <u>AN162</u>).

Data Registers (DR)

Each of the four DCPs has four 8-bit nonvolatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four data registers and the associated Wiper Counter Register. All operations changing data in one of the data registers is a nonvolatile operation and takes a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as regular memory locations for system parameters or user preference data.

Bit [7:0] are used to store one of the 256 wiper positions $(0 \sim 255)$.

TABLE 1. WIPER COUNTER REGISTER, WCR (8-BIT), WCR[7:0]: USED TO STORE THE CURRENT WIPER POSITION (VOLATILE).

WCR7	WCR6	WCR5	WCR4	WCR3	WCR2	WCR1	WCR0
(MSB)							(LSB)

TABLE 2. DATA REGISTER, DR (8-BIT), BIT [7:0]: USED TO STORE WIPER POSITIONS OR DATA (NONVOLATILE).

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT O
(MSB)							(LSB)

Serial Interface

The X9259 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master always initiates data transfers and provide the clock for both transmit and receive operations. Therefore, the X9259 operates as a slave device in all applications.

All 2-wire interface operations must begin with a START, followed by an Identification Byte, that selects the X9259. All communication over the 2-wire interface is conducted by sending the MSB of each byte of data first.

Clock and Data Conventions

Data states on the SDA line can change only during SCL LOW periods. SDA state changes during SCL HIGH are reserved for indicating START and STOP conditions (see <u>Figure 2</u>). On power-up of the X9259, the SDA pin is in the input mode.

START Condition

All commands to the X9259 are preceded by the start condition, which is a HIGH to LOW transition of SDA while SCL is HIGH. The X9259 continuously monitors the SDA and SCL lines for the START condition and does not respond to any command until this condition is met (see Figure 2).

STOP Condition

All communications must be terminated by a STOP condition, which is a LOW to HIGH transition of SDA while SCL is HIGH, (see Figure 2). The STOP condition is also used to place the device into the Standby Power mode after a Read sequence. A STOP

condition can only be issued after the transmitting device has released the bus.

Acknowledge

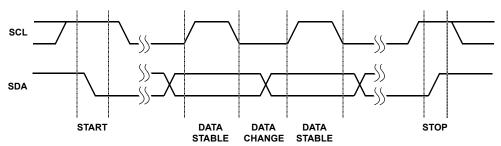
An ACK, Acknowledge, is a software convention used to indicate a successful data transfer. The transmitting device, either master or slave, releases the SDA bus after transmitting eight bits. During the ninth clock cycle, the receiver pulls the SDA line LOW to acknowledge the reception of the eight bits of data, (see Figure 3).

The X9259 responds with an ACK after recognition of a START condition followed by a valid Identification Byte, and once again after successful receipt of an Instruction Byte. The X9259 also responds with an ACK after receiving a Data Byte after a Write Instruction.

A valid Identification Byte contains the Device Type Identifier 0101, as the four MSBs, and the Device Address bits matching the logic states of pins A3, A2, A1, and A0, as the four LSBs (see Figure 4 on page 8).

In the Read mode, the device transmits eight bits of data, releases the SDA line, and then monitors the line for an ACK. The device continues transmitting data if an ACK is detected. The device terminates further data transmissions if an ACK is not detected. The master must then issue a STOP condition to place the device into a known state.

During the internal nonvolatile Write operation, the X9259 ignores the inputs at SDA and SCL, and does not issue an ACK after Identification bytes.





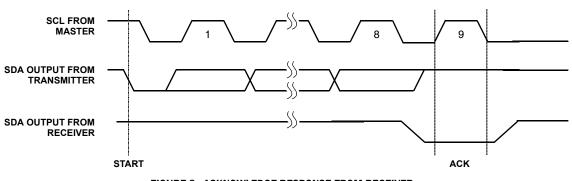


FIGURE 3. ACKNOWLEDGE RESPONSE FROM RECEIVER



Identification Byte

The first byte sent to the X9259 from the host is called the Identification Byte. The most significant four bits are a Device Type Identifier, ID[3:0] bits, which must be 0101. Refer to Table 3.

Only the device which Slave Address matches the incoming device address sent by the master executes the instruction. The A3 - A0 inputs can be actively driven by CMOS input signals or tied to V_{CC} or V_{SS} .

INSTRUCTION BYTE (I)

The next byte sent to the X9259 contains the instruction and register pointer information. The four most significant bits are used provide the instruction opcode I [3:0]. The RB and RA bits point to one of the four data registers of each associated XDCP.

The least two significant bits point to one of four Wiper Counter Registers or DCPs. The format is shown in <u>Table 4</u>.

Data Register Selection

REGISTER	RB	RA
DR#0	0	0
DR#1	0	1
DR#2	1	0
DR#3	1	1
#: 0, 1, 2, or 3	•	

The least significant four bits of the Identification Byte are the Slave Address bits, AD[3:0]. To access the X9259, these four bits must match the logic values of pins A3, A2, A1, and A0.

TABLE 3. IDENTIFICATION BYTE FORMAT

	DEVICE TYPE	E IDENTIFIER			SLAVE A	DDRESS	
ID3	ID2	ID1	ID0	A3	A2	A1	AO
0	1	0	1		Logic value of pins	A3, A2, A1, and A0	
(MSB)							(LSB)

TABLE 4. INSTRUCTION BYTE FORMAT

	INSTRUCTIO	ON OPCODE		REGISTER	SELECTION		LECTION LECTION)
13	12	11	10	RB	RA	P1	P0
(MSB)							(LSB)

			I	NSTRU	CTION	SET			
INSTRUCTION	13	12	11	10	RB	RA	P1	P0	OPERATION
Read Wiper Counter Register	1	0	0	1	0	0	1/0	1/0	Read the contents of the Wiper Counter Register pointed to by P1 - P0
Write Wiper Counter Register	1	0	1	0	0	0	1/0	1/0	Write new value to the Wiper Counter Register pointed to by P1 - P0
Read Data Register	1	0	1	1	1/0	1/0	1/0	1/0	Read the contents of the Data Register pointed to by P1 - P0 and RB - RA
Write Data Register	1	1	0	0	1/0	1/0	1/0	1/0	Write new value to the Data Register pointed to by P1 - P0 and RB - RA
XFR Data Register to Wiper Counter Register	1	1	0	1	1/0	1/0	1/0	1/0	Transfer the contents of the Data Register pointed to by P1 - P0 and RB - RA to its associated Wiper Counter Register
XFR Wiper Counter Register to Data Register	1	1	1	0	1/0	1/0	1/0	1/0	Transfer the contents of the Wiper Counter Register pointed to by P1 - P0 to the Data Register pointed to by RB - RA
Global XFR Data Registers to Wiper Counter Registers	0	0	0	1	1/0	1/0	0	0	Transfer the contents of the Data Registers pointed to by RB - RA of all four pots to their respective Wiper Counter Registers
Global XFR Wiper Counter Registers to Data Register	1	0	0	0	1/0	1/0	0	0	Transfer the contents of both Wiper Counter Registers to their respective data Registers pointed to by RB - RA of all four DCPs
Increment/Decrement Wiper Counter Register	0	0	1	0	0	0	1/0	1/0	Enable Increment/decrement of the Control Latch pointed to by P1 - P0

TABLE 5. INSTRUCTION SET

FN8169 Rev 6.00

December 12, 2014



Instructions

Four of the nine instructions are three bytes in length. These instructions are:

- Read Wiper Counter Register read the current wiper position of the selected potentiometer.
- Write Wiper Counter Register change current wiper position of the selected potentiometer.
- **Read Data Register** read the contents of the selected Data Register.
- Write Data Register write a new value to the selected Data Register.

The basic sequence of the three byte instructions is illustrated in Figure 5. These three-byte instructions exchange data between the WCR and one of the Data Registers. A transfer from a Data Register to a WCR is essentially a write to a static RAM, with the static RAM controlling the wiper position. The response of the wiper to this action is delayed by t_{WRL} . A transfer from the WCR (current wiper position), to a Data Register is a write to nonvolatile memory and takes a minimum of t_{WR} to complete. The transfer can occur between one of the four potentiometer's WCR, and one of its associated registers, DRs; or it may occur globally, where the transfer occurs between all potentiometers and one associated register.

Four instructions require a two-byte sequence to complete. These instructions transfer data between the host and the X9259; either between the host and one of the data registers or directly

between the host and the Wiper Counter Register. These instructions are:

- XFR Data Register to Wiper Counter Register This transfers the contents of one specified Data Register to the associated Wiper Counter Register.
- XFR Wiper Counter Register to Data Register This transfers the contents of the specified Wiper Counter Register to the specified associated Data Register.
- Global XFR Data Register to Wiper Counter Register – This transfers the contents of all specified Data Registers to the associated Wiper Counter Registers.
- Global XFR Wiper Counter Register to Data Register – This transfers the contents of all Wiper Counter Registers to the specified associated Data Registers.

Increment/Decrement Command

The final command is Increment/Decrement (Figures 6 and 7). The Increment/Decrement command is different from the other commands. Once the command is issued and the X9259 has responded with an Acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby, providing a fine tuning capability to the host. For each SCL clock pulse (t_{HIGH}) while SDA is HIGH, the selected wiper moves one wiper position towards the R_{H} terminal. Similarly, for each SCL clock pulse while SDA is LOW, the selected wiper moves one resistor wiper position towards the R_{L} terminal.

See <u>"Instruction Format" on page 10</u> for more details.

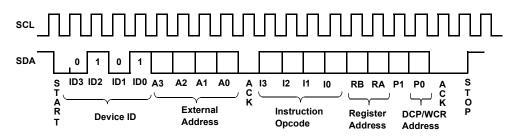


FIGURE 4. TWO-BYTE INSTRUCTION SEQUENCE

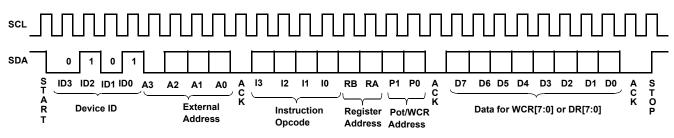


FIGURE 5. THREE-BYTE INSTRUCTION SEQUENCE 2-WIRE INTERFACE



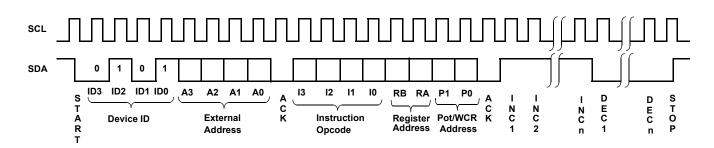
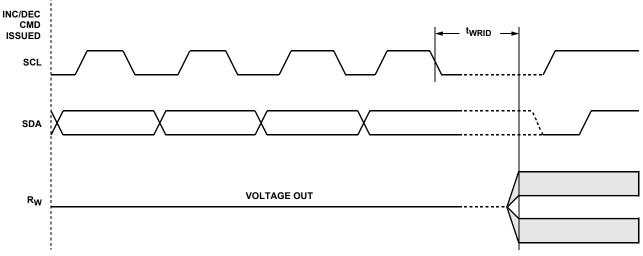


FIGURE 6. INCREMENT/DECREMENT INSTRUCTION SEQUENCE 2-WIRE INTERFACE





Instruction Format

Read Wiper Counter Register (WCR)

S T	_	EVICI				DE\ ADDR	/ICE ESSES	5	s	11		UCTIC ODE	DN			/WCR RESSE		s		(SE	WIF NT B		POSIT 259 (DA)		м	s
А Т	0	1	0	1	A3	A2	A1	AO	A C K	1	0	0	1	0	0	P1	PO	A C K	W C R 7	W C R 6	W C R 5	W C R 4	W C R 3	W C R 2	W C R 1	W C R O	A C K	Т О Р

Write Wiper Counter Register (WCR)

S T		DEVIC					VICE ESSES	5	s	IN		UCTIC ODE				/WCR Resse		s		(SEI	WIF NT BY		POSIT STER		SDA)		s	s
A R T	0	1	0	1	A3	A2	A1	AO	A C K	1	0	1	0	0	0	P1	PO	A C K	W C R 7	W C R 6	W C R 5	W C R 4	W C R 3	W C R 2	W C R 1	W C R O	A C K	T O P

Read Data Register (DR)

S T			E TYI IIFIE		A		/ICE ESSE	s	s			UCTI ODE			DR/ ADDR		S	s					259)	м	s
A R T	0	1	0	1	A3	A2	A1	AO	A C K	1	0	1	1	RB	RA	P1	PO	A C K	W C R 7	W C R 6	W C R 5	W C R 4	W C R 3	W C R 2	W C R 1	W C R O	A C K	Т О Р

Write Data Register (DR)

S T		evici Den1			A	DE\ ADDR	/ICE ESSE	s	s			JCTI ODE		ļ	DR/ ADDR	WCR ESSE	s	s	(5				Posi Stef		I SD/	A)	s	s	AGE CLE
A R T	0	1	0	1	A3	A2	A1	AO	A C K	1	1	0	0	RB	RA	P1	PO	A C K	W C R 7	W C R 6	W C R 5	W C R 4	W C R 3	W C R 2	W C R 1	W C R O	A C K	T O P	HIGH-VOLT WRITE CY

Global XFR Data Register (DR) to Wiper Counter Register (WCR)

S T	-	evici Den1		-			/ICE ESSE	s	S A		stri Opc				DR/ ADDR			S A	S T
A R T	0	1	0	1	A3	A2	A1	A0	С К	0	0	0	1	RB	RA	0	0	С К	0 P

Global XFR Wiper Counter Register (WCR) to Data Register (DR)

S T	-		e tyf Iifief	-	A	DE\ DDR	/ICE ESSE	s	S A			UCTI ODE			DR/W DDRE		5	S A	S T	HIGH-VOLTAGE
A R T	0	1	0	1	A3	A2	A1	A0	С К	1	0	0	0	RB	RA	0	0	С К	0 P	WRITE CYCLE

Transfer Wiper Counter Register (WCR) to Data Register (DR)

S T	_	EVIC DEN1			A		/ICE ESSE	s	S A		STRI OPC				DR/ Addr		5	S A	S T	HIGH-VOLTAGE
A R T	0	1	0	1	A3	A2	A1	AO	С К	1	1	1	0	RB	RA	P1	P0	С К	0 P	WRITE CYCLE

Transfer Data Register (DR) to Wiper Counter Register (WCR)

S T	_		E TYF IIFIEF	-	A		/ICE ESSE	S	S A		STRI OPC					WCR ESSES	5	S A	S T
A R T	0	1	0	1	A3	A2	A1	A0	с к	1	1	0	1	RB	RA	P1	P0	С К	0 P

Increment/Decrement Wiper Counter Register (WCR)

S T		evici Den1			A		/ICE ESSE	s	S A		stri Opc					r/WCR Dressi		S A		INCF (SEN						S T
A R T	0	1	0	1	A3	A2	A1	A0	С К	0	0	1	0	0	0	P1	P0	С К	I/D	I/D	•	•	•	I/D	I/D	0 P

NOTES:

5. "MACK"/"SACK": stands for the acknowledge sent by the Master/Slave.

6. "A3 ~ A0": stands for the device addresses sent by the master.

7. "X": indicates that it is a "0" for testing purpose but physically it is a "don't care" condition.

8. "I": stands for the increment operation, SDA held high during active SCL phase (high).

9. "D": stands for the decrement operation, SDA held low during active SCL phase (high).

Absolute Maximum Ratings

Temperature under bias	65°C to +135°C
Storage temperature	65°C to +150°C
Voltage on SCL, SDA, any address input, V _{CC}	
with respect to V _{SS}	1V to +7V
$\Delta \mathbf{V} = (\mathbf{V}_{\mathbf{H}} - \mathbf{V}_{\mathbf{L}}) \dots$	5.5V
Lead temperature (soldering, 10 seconds)	300°C
I _W (10 seconds)	±6mA

Recommended Operating Conditions

Temperature (Commercial)	0°C to +70°C
Temperature (Industrial)	40°C to +85°C
Supply Voltage (V _{CC}) (<u>Note 13</u>) Limits	
X9259	5V ± 10%
X9259-2.7	2.7V to 5.5V
Wiper current	±3mA
Power rating (each pot)	50mW
Pb-Free Reflow Profile	see <u>TB493</u>

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

Analog Specifications	Over recommended industrial (2.7V) operating conditions unless otherwise stated
-----------------------	---

				LI	MITS	
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
R _{TOTAL}	End-to-End Resistance	U version		50		kΩ
	End-to-End Resistance Tolerance				±20	%
R _W	Wiper Resistance	$I_W = \frac{V(V_{CC})}{R_{TOTAL}}$ at $V_{CC} = 3V$			300	Ω
		$I_W = \frac{V(V_{CC})}{R_{TOTAL}}$ at $V_{CC} = 5V$			220	Ω
V _{TERM}	Voltage on any R _H or R _L Pin	V _{SS} = 0V	V _{SS}		v _{cc}	v
	Noise (<u>Note 15</u>)	Ref: 1V		-120		dB/√Hz
	Resolution			0.4		%
	Absolute Linearity (Note 10)	Rw(n)(actual) - Rw(n)(expected) (Note 14)	-1		+1	MI (<u>Note 12</u>
	Relative Linearity (<u>Note 11</u>)	$R_{w(n + 1)} - [R_{w(n) + MI}] (Note 14)$	-0.6		+0.6	MI (<u>Note 12</u>
	Temperature Coefficient of R _{TOTAL} (Note 15)			±300		ppm/°C
	Ratiometric Temp. Coefficient (Note 15)			±20		ppm/°C
C _H /C _L /C _W	Potentiometer Capacitances (Note 15)	See SPICE Macromodel on page 14.		10/10/25		pF

NOTES:

10. Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.

11. Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.

12. MI = RTOT / 255 or (R_H – R_L) / 255, single pot

13. During power up V_{CC} > V_H, V_L, and V_W.

14. n = 0, 1, 2, ..., 255; m = 0, 1, 2, ..., 254.

DC Electrical Specifications ov	ver the recommended operating conditions unless otherwise specified.
--	--

				LIM	AITS	
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
ICC1	V _{CC} supply current (active)	f _{SCL} = 400kHz; V _{CC} = +6V; SDA = Open; (for 2-Wire, Active, Read and Volatile Write States only)			3	mA
I _{CC2}	V _{CC} supply current (nonvolatile write)	f _{SCL} = 400kHz; V _{CC} = +6V; SDA = Open; (for 2-Wire, Active, Nonvolatile Write State only)			5	mA
I _{SB}	V _{CC} current (standby)	V_{CC} = +6V; V_{IN} = V_{SS} or V_{CC} ; SDA = V_{CC} ; (for 2-Wire, Standby State only)			5	μA
ILI	Input leakage current	$V_{IN} = V_{SS}$ to V_{CC}			10	μA
ILO	Output leakage current	$V_{OUT} = V_{SS}$ to V_{CC}			10	μA
VIH	Input HIGH voltage		V _{CC} x 0.7			v
VIL	Input LOW voltage				V _{CC} x 0.3	v
V _{OL}	Output LOW voltage	I _{OL} = 3mA			0.4	v
V _{OH}	Output HIGH voltage	I_{OH} = -1mA, $V_{CC} \ge$ +3V	V _{CC} - 0.8			v
v _{он}	Output HIGH voltage	I_{OH} = -0.4mA, $V_{CC} \le +3V$	V _{CC} - 0.4			v

Endurance and Data Retention

PARAMETER	MIN	UNITS
Minimum endurance	100,000	Data changes per bit per register
Data retention	100	years

Capacitance

SYMBOL	TEST	MAX	UNITS	TEST CONDITIONS
CIN/OUT (Note 15)	Input / Output capacitance (SDA)	8	pF	V _{OUT} = OV
C _{IN} (<u>Note 15</u>)	Input capacitance (SCL, \overline{WP} , A2, A1 and A0)	6	pF	V _{IN} = OV

Power-up Timing

SYMBOL	PARAMETER	MIN	МАХ	UNITS
tr VCC (<u>Note 15</u>)	V _{CC} Power-up rate	0.2		V/ms
tPUR (<u>Note 16</u>)	Power-up to initiation of read operation		1	ms
tPUW (<u>Note 16</u>)	Power-up to initiation of write operation		50	ms

AC Test Conditions

Input Pulse Levels	$V_{CC} \times 0.1$ to $V_{CC} \times 0.9$	
Input rise and fall times	10ns	
Input and output timing level	V _{CC} x 0.5	

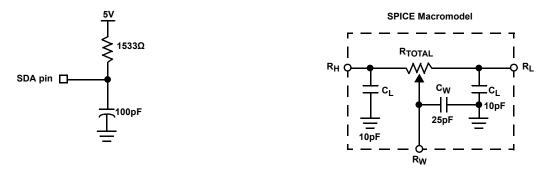
NOTES:

15. This parameter is not 100% tested

16. t_{PUR} and t_{PUW} are the delays required from the time the power supply (V_{CC}) is stable until the specific instruction can be issued. These parameters are periodically sampled and not 100% tested.



Equivalent AC Load Circuit



AC Timing

SYMBOL	PARAMETER	MIN	MAX	UNITS	
fscl	Clock Frequency		400	kHz	
t _{CYC}	Clock Cycle Time	2500		ns	
thigh	Clock High Time	600		ns	
t _{LOW}	Clock Low Time	1300		ns	
^t su:sta	Start Setup Time	600		ns	
t _{HD:STA}	Start Hold Time	600		ns	
t _{SU:STO}	Stop Setup Time	600		ns	
^t su:dat	SDA Data Input Setup Time	100	ns		
t _{HD:DAT}	SDA Data Input Hold Time	30	ns		
t _R	SCL and SDA Rise Time		300 n		
t _F	SCL and SDA Fall Time		300	ns	
t _{AA}	SCL Low to SDA Data Output Valid Time		0.9	μs	
t _{DH}	SDA Data Output Hold Time	0	ns		
т _I	Noise Suppression Time Constant at SCL and SDA inputs	50	ns		
t _{BUF}	Bus Free Time (Prior to Any Transmission)	1200	ns		
t _{SU:WPA}	A0, A1 Setup Time	0	ns		
thd:wpa	A0, A1 Hold Time	0		ns	

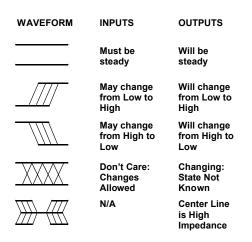
High-Voltage Write Cycle Timing

SYMBOL	PARAMETER	MAX	UNITS	
t _{WR}	High-voltage write cycle time (store instructions)	5	10	ms

XDCP Timing

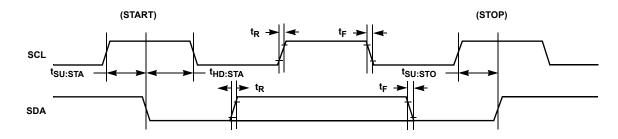
SYMBOL	PARAMETER	MIN	MAX	UNITS
^t WRP0	Wiper response time after the third (last) power supply is stable	5	10	μs
twrl	Wiper response time after instruction issued (all load instructions)	5	10	μs

Symbol Table



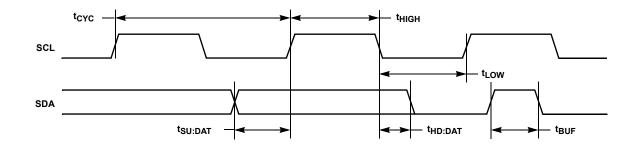
Timing Diagrams

Start and Stop Timing

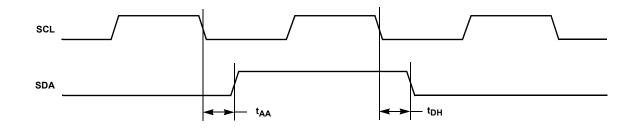


.

Input Timing

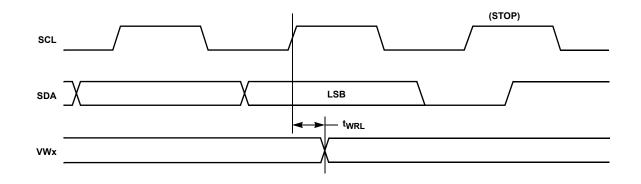


Output Timing

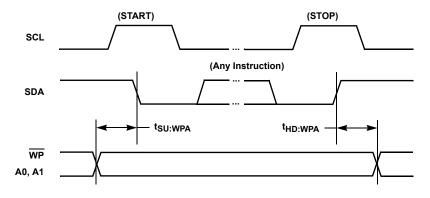








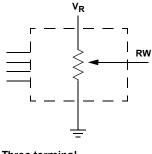
Write Protect and Device Address Pins Timing



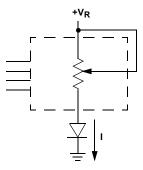


Applications Information

Basic Configurations of Electronic Potentiometers



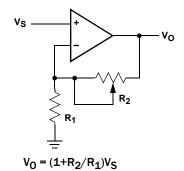
Three-terminal Potentiometer; Variable voltage divider



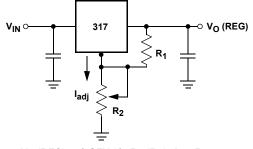
Two-terminal Variable Resistor; Variable current

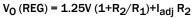
Application Circuits

Non inverting Amplifier

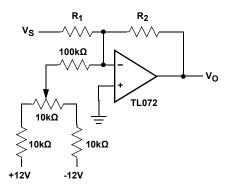


Voltage Regulator

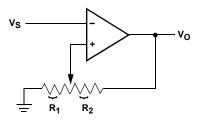




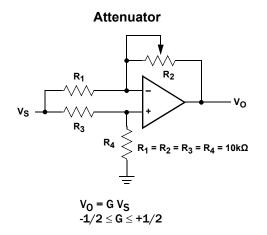
Offset Voltage Adjustment

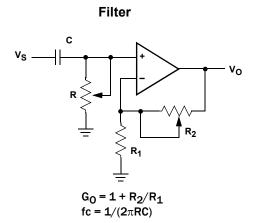


Comparator with Hysteresis

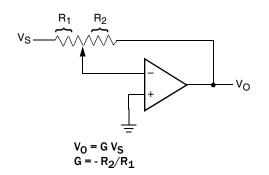


Application Circuits (continued)

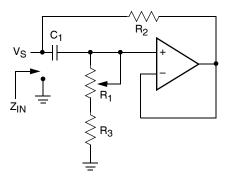




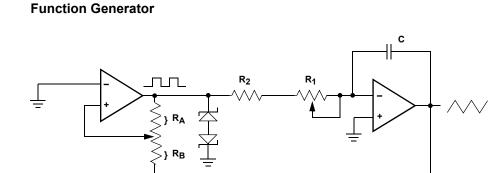
Inverting Amplifier



Equivalent L-R Circuit



 $Z_{IN} = R_2 + s R_2 (R_1 + R_3) C_1 = R_2 + s Leq$ (R₁ + R₃) >> R₂



frequency \propto R_1, R_2, C amplitude \propto R_A, R_B

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
December 12, 2014	FN8169.6	Updated Datasheet to Intersil new standards. Updated Ordering Information Table on page 2, by removing obsoleted parts and 100kΩ referenced parts, adding Note 3 and changed TSSOP POD references from "MDP0044" to "M24.173". On page 3. in the Pin Descriptions table removed duplicate entry for Pin 6. Added Revision History and About Intersil Verbiage Updated M24.3 POD to the latest revision. -"Updated to new POD standard by removing table listing dimensions and putting dimensions on drawing. Added Land Pattern." Replaced MDP0044 POD with M24.173 POD to update to new format and only show 24LD version.

About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at <u>www.intersil.com</u>.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.

Reliability reports are also available from our website at www.intersil.com/support

© Copyright Intersil Americas LLC 2005-2014. All Rights Reserved. All trademarks and registered trademarks are the property of their respective owners.

For additional products, see www.intersil.com/en/products.html

Intersil products are manufactured, assembled and tested utilizing ISO9001 quality systems as noted in the quality certifications found at <u>www.intersil.com/en/support/qualandreliability.html</u>

Intersil products are sold by description only. Intersil may modify the circuit design and/or specifications of products at any time without notice, provided that such modification does not, in Intersil's sole judgment, affect the form, fit or function of the product. Accordingly, the reader is cautioned to verify that datasheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

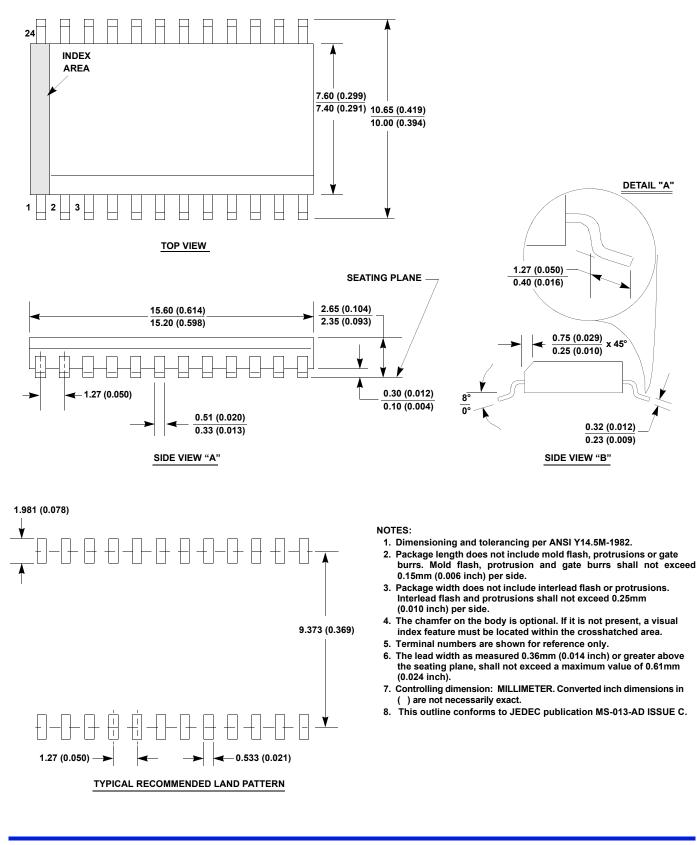
FN8169 Rev 6.00 December 12, 2014



Package Outline Drawing M24.3

24 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE (SOIC)

Rev 2, 3/11

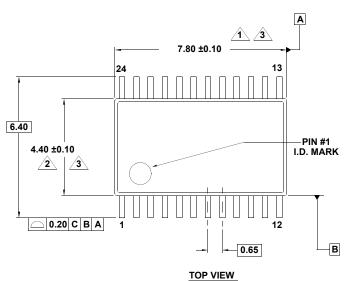


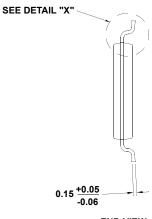


Package Outline Drawing

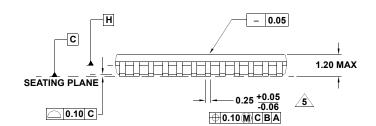
M24.173

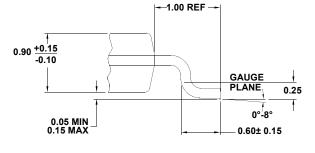
24 LEAD THIN SHRINK SMALL OUTLINE PACKAGE (TSSOP) Rev 1, 5/10



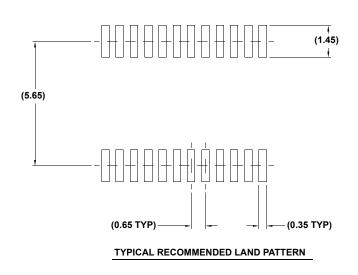








SIDE VIEW



NOTES:

1. Dimension does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 per side.

DETAIL "X"

- 2. Dimension does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 per side.
- 3. Dimensions are measured at datum plane H.
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 5. Dimension does not include dambar protrusion. Allowable protrusion shall be 0.08mm total in excess of dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm.
- 6. Dimension in () are for reference only.
- 7. Conforms to JEDEC MO-153.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Renesas Electronics:

X9259UV24IZ X9259UV24IZ-2.7 X9259UV24IZ-2.7T1 X9259UV24IZT1 X9259UV24Z X9259UV24Z-2.7